Title (en)
Method and apparatus for heat treating at least one metal wire by means of heat transfer plates.

Title (de)
Verfahren und Vorrichtung zur Wärmebehandlung mindestens eines Metalldrahtes mittels Wärmeaustauschplatten.

Title (fr)
Procédé et dispositif pour traiter thermiquement au moins un fil metallique avec des plaques de transfert thermique.

Publication
EP 0410300 B1 19940601 (FR)

Application
EP 90113824 A 19900719

Priority
FR 8910324 A 19890726

Abstract (en)
[origin: EP0410300A1] Method and apparatus (100) for heat-treating at least one metal wire (1), characterised in that the wire (1) is passed through at least one pair of heat transfer plates (2, 2a, 2b), between two grooves (8, 8a, 8b) made in the two plates (2, 2a, 2b) of each of these pairs, it being possible for the separating distance (E) between the plates to vary, the wire (1) being directly in contact with a gas (11) practically devoid of forced ventilation arranged between the grooves (8, 8a, 8b). Metal wires (1) obtained with this method and this apparatus (100). <IMAGE>

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C21D 9/573; C21D 9/56; C21D 9/64

IPC 8 full level
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